	Tomporatura											
Rating	Temperature Range Voltage		Signal Contact : 50 V AC Power Contact : 200 V AC Signal Contact : 0.5 A			mperature Range prage Humidity Range			-10 °C to 60 Relative humidity 85% (Not dewed)		.,	
	Current										[
			Power Contact : 3.0A				Humidity Range					
			SPEC	IFICAT	<u>FION</u>	S						
	EM		TEST METHOD				REC	QUIR	EMENTS	QT	A	
											1	
General Examination Marking		Visually and by measuring instrument. Confirmed visually.			'	According to drawing.				×	×	
ELECTRIC CHARAC										^	^	
Contact Res			DC or 1000Hz)			Signal	Contact : 7	70m Ω	MAX.	×	-	
									MAX. 🖄			
Insulation Resistance		Signal Contact : 100 V DC. Power Contact : 250 V DC 1				Signal Contact : 100 M Ω MIN. Power Contact : 1000 M Ω MIN. 1				×	_	
Voltage Proof		Signal Contact : 150 V AC for 1 min. Power Contact : 600 V AC for 1 min.				No flashover or breakdown.				× ×	×	
MECHAN	CAL CHAP	RACTERI	STICS							·		
Insertion and		Measured by applicable connector.				Insertion Force: 9 N MAX 1				×	-	
Withdrawal Forces Mechanical Operation		100 times insertions and extractions.				Withdrawal Force: 1 N MIN. ① Contact Resistance:				×	-	
						Signal Contact : $80m \Omega$ MAX. $\Delta 1$ Power Contact : $30m \Omega$ MAX. (2) No damage, crack and looseness of parts.						
Vibration		Frequency 10 to 55 to 10Hz, approx 5min Single amplitude : 0.75 mm, 10 cycles			(No electrical discontinuity of 1 μs. No damage, crack and looseness of parts. 				×	-	
Shock		for 3 axial directions. 490 m/s ² , duration of pulse 11 ms at 3 times for 3 both axial directions.								×	-	
ENVIRON	MENTAL (TERISTICS									
Damp Heat (Steady state)		Exposed at 40±2 °C, 90 ~ 95 %, 96 h.			(~	tact Resis		: 80mΩ MAX.	×	-	
Rapid Change of Temperature		Temperat	Temperature -55 → +85 °C			Λ Power Contact : 30m Ω MAX.				×	- 1	
		Time $30 \rightarrow 30$ min. under 5 cycles.				 Insulation Resistance: Signal Contact : 100 MΩ MIN. A Device Contact : 1000 MΩ MIN. 						
		(Relocation time to chamber : within 2~3 MIN)				Power Contact : 1000 MΩ MIN. No damage, crack and looseness of parts.						
Cold		Exposed at -55°C, 96 h			(① Contact Resistance: Signal Contact : 80m Ω MAX.				×	-	
Dry Heat		Exposed at 85°C, 96 h			(2 Power Contact : 30m Ω MAX. 2 No damage, crack and looseness of parts.				×	-	
Sulfur Dioxide		Exposed at $25\pm2^{\circ}$ C, $75\pm5^{\circ}$ RH, 25 PPM for 96 h. (Test standard: IEC 68) $/_{1}$			6 h. 🤇	 No defect such as corrosion which impairs the function of connector. 				×	-	
						 Contact Resistance: 						
			1)Reflow soldering :				Signal Contact : $80m\Omega$ MAX.					
							<u>1</u> Power Contact : 30m Ω MAX. No deformation of case of excessive					
Soldering Heat		Peak T	Peak TMP : 260°CMAX Reflow TMP: 220°CMIN for 60sec			looseness of the terminal.				×		
		2) Solder	ing irons : 360°C MAX. for 5	sec.								
Solderability		Soldered at solder temperature $240\pm3^{\circ}$ C for immersion duration, 3 sec.			I	A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed.				×	-	
COUN	іт с	DESCRIPTI	ON OF REVISIONS		DESIGI		cu.		CHECKED	DA	ATE	
			DIS-F-00000643 TS. 0)ONO			KN. SHIBUYA		9. 09	
REMARKS ⁽¹⁾ Include temperature rise caused by			sed by current-carrying.	by current-carrying.			APPROVED		HS. OKAWA		14. 09. 02	
	⁽²⁾ "STORAGE" r before assem	-	ns a long-term storage state for the unused product to PCB.			CHECKED		D	KN. SHIBUYA)9. 02	
Unless otherwise specified, r			<u>^</u>			DESIGNED DRAWN			TS. 00N0 TS. 00N0	14.09.0 14.09.0		
Note QT:Qualification Test AT:Assurance Test X:Applicable Test				DR	DRAWING NO.			ELC-353565-00-00				
Note Q1.Q	SPECIFICATION SHEET					PART NO.			FX23-20S-0. 5SH			
	S	SPECIFI	CATION SHEET		PART	NO.		F	X23-20S-0. 5SH		1	

2015/09/18 00:25:23(JST) ctanke

DRAWING FOR REFERENCE: This is subject to change without notice

FORM HD0011-2-1

